

GP1S27

Subminiature Photointerrupter

■ Features

1. Ultra-compact
2. PWB mounting type package
3. Current transfer ratio
(CTR : MIN. 4.3%)

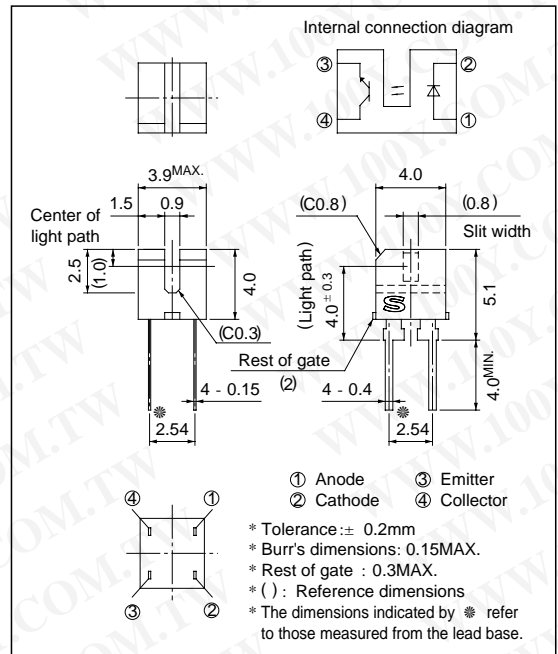
■ Applications

1. Cameras
2. Floppy disk drives

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

■ Outline Dimensions

(Unit : mm)

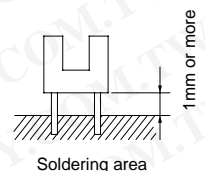


■ Absolute Maximum Ratings

(Ta = 25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	50	mA
	Reverse voltage	V _R	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	V _{CEO}	35	V
	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	I _C	20	mA
	Collector power dissipation	P _C	75	mW
	Total power dissipation	P _{tot}	100	mW
	Operating temperature	T _{opr}	- 25 to + 85	°C
Storage temperature	T _{sig}	- 40 to + 100	°C	
	*1 Soldering temperature	T _{sol}	260	°C

*1 For 5 seconds



■ Electro-optical Characteristics

($T_a = 25^\circ\text{C}$)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F = 20\text{mA}$	-	1.2	1.4	V
	Reverse current	I_R	$V_R = 3\text{V}$	-	-	10	μA
Output	Collector dark current	I_{CEO}	$V_{CE} = 20\text{V}$	-	-	1×10^{-7}	A
Transfer characteristics	Collector Current	I_C	$I_F = 1.5\text{mA}, V_{CE} = 5\text{V}$	65	-	200	μA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F = 3\text{mA}, I_C = 30\mu\text{A}$	-	-	0.4	V
	Response time	Rise time	t_r	$V_{CE} = 5\text{V}, R_L = 1\text{k}\Omega$	-	50	150
Fall time		t_f	$I_C = 100\mu\text{A}$	-	50	150	μs

Fig. 1 Forward Current vs. Ambient Temperature

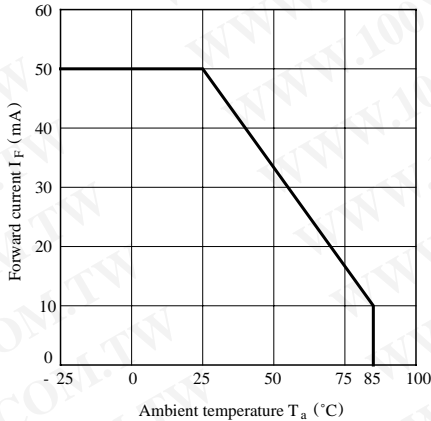


Fig. 2 Power Dissipation vs. Ambient Temperature

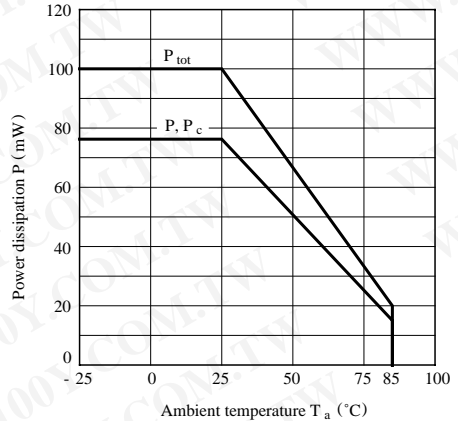


Fig. 3 Forward Current vs. Forward Voltage

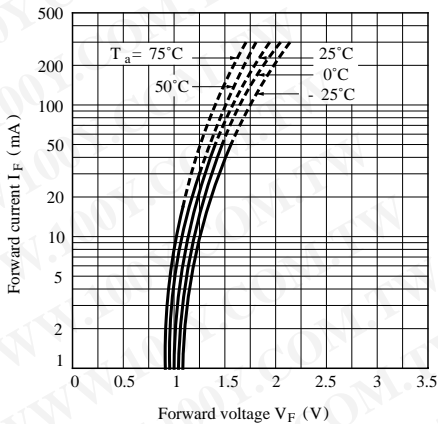


Fig. 4 Collector Current vs. Forward Current

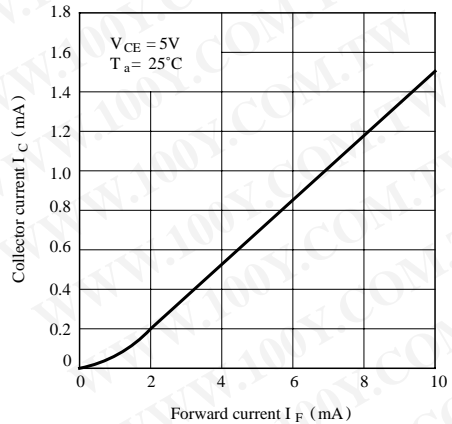


Fig. 5 Collector Current vs. Collector-emitter Voltage

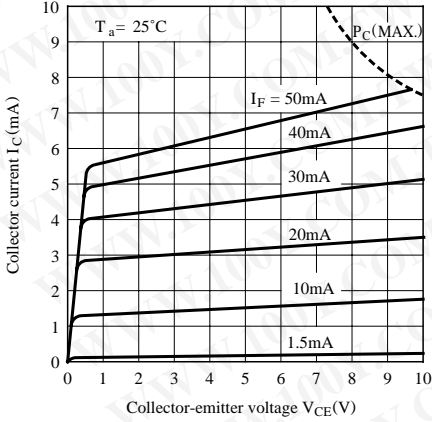


Fig. 6 Collector Current vs. Ambient Temperature

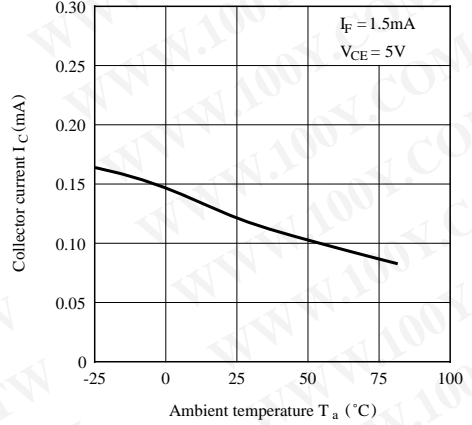


Fig. 7 Collector-emitter Saturation Voltage vs. Ambient Temperature

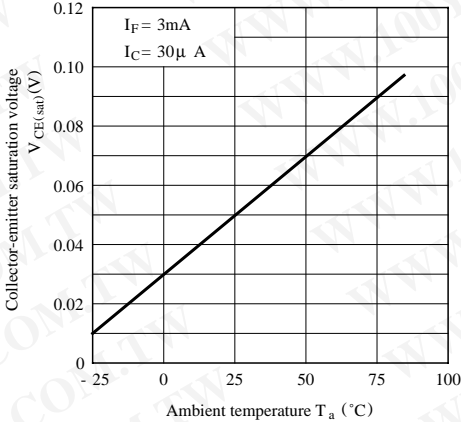


Fig. 8 Collector Dark Current vs. Ambient Temperature

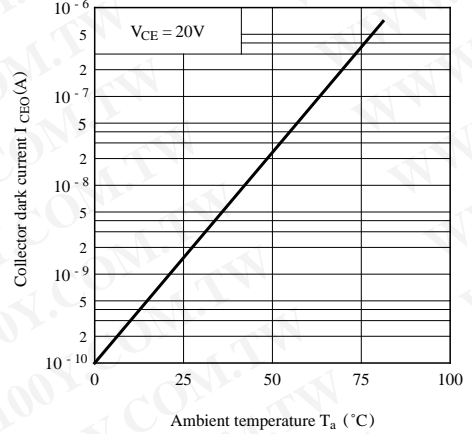
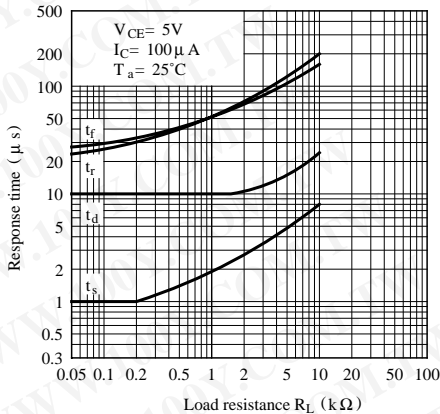


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

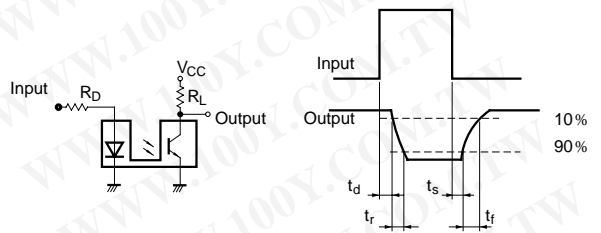


Fig.10 Relative Collector Current vs. Shield Distance (1)

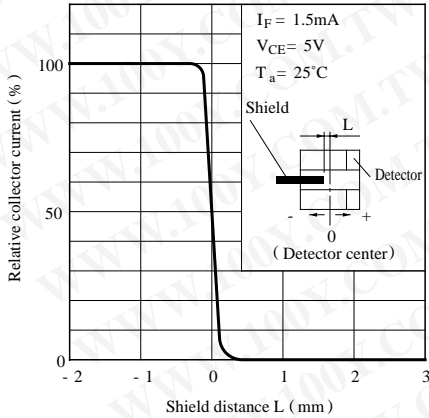
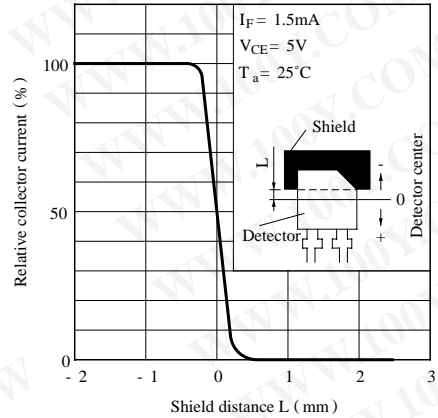


Fig.11 Relative Collector Current vs. Shield Distance (2)



■ Precautions for Use

- (1) Please refrain from soldering under preheating and refrain from soldering by reflow.
- (2) As for other general cautions, refer to the chapter "Precautions for Use".